

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YOHEI YAMAUCHI	08/19/2014
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Honda Motor Co., Ltd.
<b>Street Address:</b>	1-1, Minami-Aoyama 2-chome
<b>City:</b>	Minato-ku, Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	107-8556
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14462732
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<b>ATTORNEY DOCKET NUMBER:</b>	HGN-504-A
<b>NAME OF SUBMITTER:</b>	JOSEPH P. CARRIER
<b>SIGNATURE:</b>	/Joseph P. Carrier/
<b>DATE SIGNED:</b>	08/25/2014
<b>Total Attachments: 1</b>	
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HGN-504-A

**ASSIGNMENT**

In consideration of value received,

**Yohei YAMAUCHI**

hereinafter referred to as "Assignor", sell and assign to

**Honda Motor Co., Ltd.**

a corporation of Japan, having a place of business at

**1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo, 107-8556 Japan**

, respectively, its successors, assigns or nominees, hereinafter referred to as "Assignee", the entire right, title and interest in and to an invention entitled:

**COUPLING STRUCTURE FOR RESIN PARTS, AND  
METHOD OF MANUFACTURING SAME**

invented by the Assignor and as described in the following:

U.S. Patent Application 14/462,732 filed electronically 19 August 2014

(Serial No. and filing date unknown at time of signing, however, Applicant's representative is specifically authorized to insert the relevant serial No. and filing date in the space above as soon as it becomes known) and in and to all applications for patent for said invention in all countries, and all divisions, reissues, continuations and extensions of any of said applications, and all rights of priority resulting from the filing of any said applications; and Assignor authorizes and requests any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and Assignor agrees that on request and without further consideration, but at the expense of said Assignee, Assignor will communicate to said Assignee or its representative any facts known to Assignor respecting said invention and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce a proper patent protection for said invention in all countries.

Subscribed and executed at

Saitama, Japan  
(City and Country)

AUG. 19. 2014

Date

Yohei YAMAUCHI

Assignor - Yohei YAMAUCHI